Yiwei ZHAO | 赵奕炜
Curriculum Vitae

Department of Electrical and Computer Engineering, Carnegie Mellon University
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RESEARCH INTERESTS

Parallel Computing, Databases, Cloud Computing, Computer Architecture, Graph Processing, Distributed Systems.

EDUCATION

Carnegie Mellon University, Pittsburgh, Pennsylvania, 2021-present.
- Ph.D. student in Electrical and Computer Engineering.
- Primary Advisor: Prof. Phillip B. Gibbons.

Tsinghua University, Beijing, China, 2017-2021.
- B.E. in Electronic Engineering. Graduated summa cum laude.
- Double major in Economics & Finance.
- **Overall GPA**: 3.9/4.0   **Ranking**: 12/241 (top 5%)

HONORS & AWARDS

- Excellence Honor for Undergraduate, Tsinghua University & Ministry of Education of Beijing (2021).
- Top Prize in Shuping Scholarship for College Students, Shuping Foundation (2020)
- China National Scholarship, Ministry of Education of China (2018 & 2019).
- Scholarship of Excellent Comprehensive Performance, Tsinghua University (2018 & 2019).
- Advanced Individual of Social Practice, Tsinghua University (2018 & 2020).
- Advanced Individual of Academic Excellence, Tsinghua University (2018).
- First Prize in Shuping Scholarship for College Students, Shuping Foundation (2018 & 2019).
- Second Prize in the 35th China Regional College Student Physics Contest, Beijing Physical Society (2018).
- Shuping Scholarship for College Freshmen, Shuping Foundation (2017).

RESEARCH EXPERIENCE

Carnegie Mellon University (Graduate Research Assistant), Pittsburgh, PA, August 2021 – present.
- Advisors: Phillip B. Gibbons, Guy E. Blelloch.
- Research Topics: Ordered Indexes for Processing-In-Memory; Parallel Graph Processing; Parallel Algorithms and Data Structures; Matrix Multiplication, Computation Geometry and Graph Procession on Novel Architecture.

University of Maryland (Research Collaborator), College Park, MD, October 2022 – present.
- Advisor: Laxman Dhulipala.
- Research Topic: Time-evolving Graph Processing.

Meta Reality Lab (Research Scientist Intern), Redmond, WA, May 2023 – August 2023.
- Host: Ziyun Li.
- Research Topic: Architecture & System Design for Edge Devices; Compute-in-memory.

Massachusetts Institute of Technology (Research Assistant), Cambridge, MA, June 2020 – November 2020.
- Advisor: Julian Shun.
- Research Topic: Parallel Spatial Clustering Algorithms & Unsupervised Learning.

Tsinghua University (Undergraduate Research Assistant), Beijing, China, September 2020 – June 2021.
- Advisor: Yongpan Liu.
- Research Topic: Error Tolerant Designs for ReRAM based Compute-In-Memory Neural Network Accelerators.

Bizseer Tech. (Research Intern), Beijing, China, May 2019 – July 2019, Jan 2020 – July 2020.
- Hosts: Xidao Wen, Dan Pei.
- Research Topic: AIOps Challenge System Design; Stream & Graph Learning.

Tsinghua University (Research Assistant), Beijing, China, January 2019 – Oct 2019.
- Advisor: Dan Pei.
- Research Topic: Fault Localization and Data Mining in Multi-dimensional Data.

PUBLICATIONS

[1] Hongbo Kang, **Yiwei Zhao**, Guy E. Blelloch, Laxman Dhulipala, Yan Gu, Charles McGuffey, and Phillip B. Gibbons. 2023. "**A Skew-resistant Trie for Processing-in-Memory**". Accepted by 35th ACM Symposium on Parallelism in Algorithms and Architectures (**SPAA**), 2023.

[2] Zeyan Li, Junjie Chen, Yihao Chen, Chengyang Luo, **Yiwei Zhao**, Yongqian Sun, Kaixin Sui, Xiping Wang, Dapeng Liu, Xing Jin, Qi Wang, and Dan Pei. 2023. "**Generic and Robust Root Cause Localization for Multi-Dimensional Data in Online Service Systems**". In Journal of Systems and Software (**JSS**), Vol. 203, (2023), 111748. doi:10.1016/j.jss.2023.111748.

[3] Hongbo Kang, **Yiwei Zhao**, Guy E. Blelloch, Laxman Dhulipala, Yan Gu, Charles McGuffey, and Phillip B. Gibbons. 2022. "**PIM-tree: A Skew-resistant Index for Processing-in-Memory**". In Proceedings of the VLDB Endowment (**PVLDB**), 16(4): 946-958, December 2022. doi:10.14778/3574245.3574275. arXiv:2211.10516.

[4] Zeyan Li, Chengyang Luo, **Yiwei Zhao**, Yongqian Sun, Kaixin Sui, Xiping Wang, Dapeng Liu, Xing Jin, Qi Wang, and Dan Pei. 2019. "**Generic and Robust Localization of Multi-Dimensional Root Cause**". In the 30th International Symposium on Software Reliability Engineering (**ISSRE**). Oct. 28-31, 2019, Berlin. doi:10.1109/ISSRE.2019.00015.

SERVICES

- **Student Council for Faculty Hiring**: Jan 2023 – present, Department of Electrical & Computer Engineering, CMU.

SKILLS

- **Programming Languages**: C/C++, Java, Python, Shell Scripting, and Assembly.
- **Software Development Tools**: GCC, MATLAB, Git, SQL, and RStudio.
- **Hardware Design Tools**: Verilog HDL, Gem5, McPAT, Multisim, and ADS.
- **Machine Learning Frameworks**: TensorFlow, and PyTorch.
- **Other Software Tools**: Mathematica, Latex, AutoCAD, and Stata.